

Discription

The HSZESD9B5.0ST5G protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.

Features

- ★ Ultra Low Capacitance 15 pF
- ★ Low Clamping Voltage
- ★ Small Body Outline Dimensions: 0.031" x 0.024" (0.80 mm x 0.60 mm)
- ★ Low Body Height: 0.015" (0.37 mm)
- ★ Stand-off Voltage: 5 V
- ★ Low Leakage
- ★ Response Time is Typically < 1.0 ns
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ This is a Pb-Free Device

Orderingin formation

Product ID	Pack	Qty(PCS)						
HSZESD9B5.0ST5G	SOD-923	8000						

Absolute Ratings(Tamb = 25°C)

Symbol	Parameter	Value	Units
P _{PP}	Peak Pulse Power ($t_p = 8/20 \ \mu \ s$)	80	W
TL	Maximum lead temperature for soldering during 10s	260	°C
T _{stg}	Storage Temperature Range	-55 to +155	°C
T _{op}	Operating Temperature Range	-40 to +125	°C
Tj	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharge contact discharge	土25 土25	ΚV

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

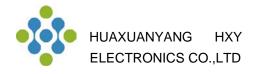
1. FR-5 = 1.0*0.75*0.62 in.







Circuit Diagram



Electrical Characteristics (T_A = 25°C unless otherwise noted)

Device	V _{RWM} (V)	I _R (μΑ) @ V _{RWM}	V _{BR} (V) @ I _T (Note 2)	г	C (pF)	V _C (V) @ I _{PP} = 5 A	lpp (A)	Ppk (W) (8*20 µS)
	Max	Max	Min	mA	Тур	Max	Max	Мах
HSESD9B5.0ST5G	5.0	0.1	5.6	1.0	15	8.5	8	80

2. V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.

Typical Characteristics

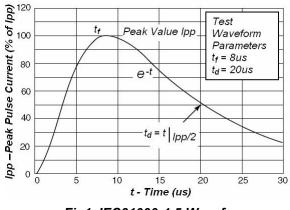


Fig1. IEC61000-4-5 Waveform

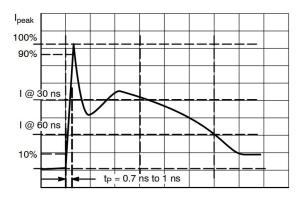
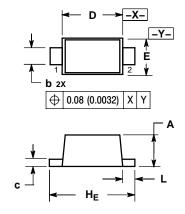


Fig2.IEC61000-4-2 Waveform



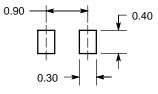
SOD-923 Outline And Dimensions



- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MIL	LIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.34	0.37	0.40	0.013	0.015	0.016	
b	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.07	0.12	0.17	0.003	0.005	0.007	
D	0.75	0.80	0.85	0.030	0.031	0.033	
Е	0.55	0.60	0.65	0.022	0.024	0.026	
H _E	0.95	1.00	1.05	0.037	0.039	0.041	
L	0.05	0.10	0.15	0.002	0.004	0.006	

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS



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